

RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:1.0AMP

Contact Resistance:20m Ω Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000M Ω Min

Operation Temperature:-40 $^{\circ}$ c to +105 $^{\circ}$ c

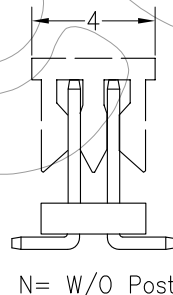
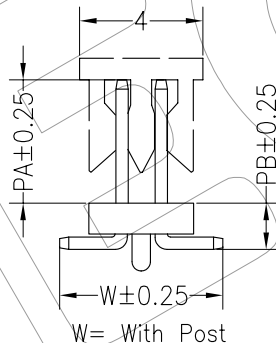
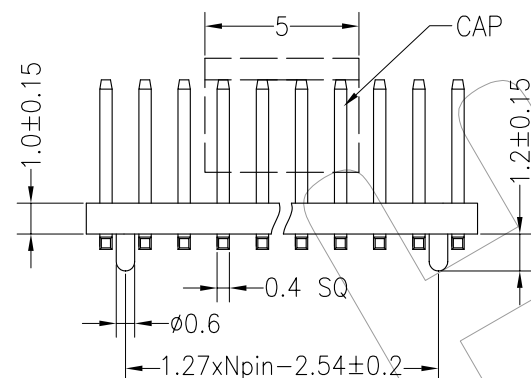
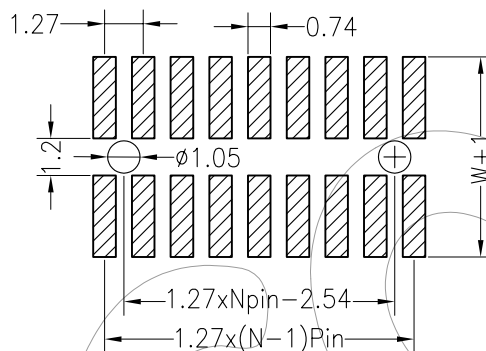
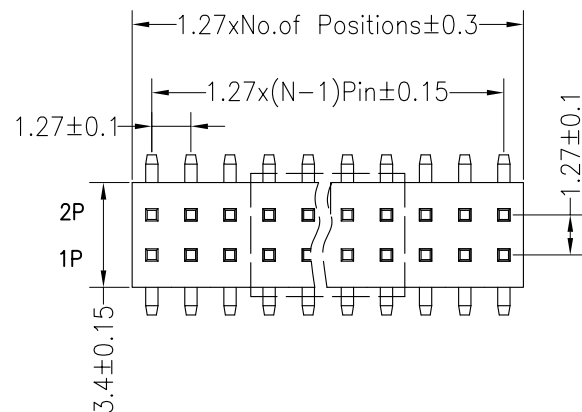
Contact Material:Brass

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 230 $^{\circ}$ C for 30-60 seconds
(260 $^{\circ}$ C for 10 seconds)



Dimension antitheses list				
ITEM	PA	PB	W	L
Standard	3.00	1.60	5.50	6.30
Alternate				

Ordering Information

HC-PH7101 2 XX X M XX X XXX X 01

No.of Pins Per Row 2*50	Insulator Material Option A=BK-PBT B=BK-PA66 C=BK-PA6T D=BK-PA46 F=BK-LCP	Contact Plating G0:Gold Flash G2:5U" Gold G3:10U" Gold G4:15U" Gold G5:30U" Gold S0:Gold Flash/Tin SN:Tin	Post W=With Post N=W/O Post	Pin Length	Packing 0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap
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OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^{\circ}$

DIM TOL

DRAW

CHECK

APPROVE

Ayang

SCALE

UNIT

SIZE

SHEET

PROJ.

FIT

mm

A4

1/1

1/1

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-PH71012XXXMXXXXXX01

TITLE:

1.27mm H1.0 Dual Row SMT Pin Header

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

DIM

TOL

NEW DRAWING